Lattice Semiconductor Corporation - LFSC3GA115E-6FC1152I Datasheet

Welcome to E-XFL.COM

Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	28750
Number of Logic Elements/Cells	115000
Total RAM Bits	7987200
Number of I/O	660
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 105°C (TJ)
Package / Case	1152-BCBGA, FCBGA
Supplier Device Package	1152-CFCBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga115e-6fc1152i

DLLs and dynamic glitch free clock MUXs which are required in today's high end system designs. High-speed, high-bandwidth I/O make this family ideal for high-throughput systems.

The ispLEVER® design tool from Lattice allows large complex designs to be efficiently implemented using the LatticeSC family of FPGA devices. Synthesis library support for LatticeSC is available for popular logic synthesis tools. The ispLEVER tool uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeSC device. The ispLEVER tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-designed IP (Intellectual Property) ispLeverCORE™ modules for the LatticeSC family. By using these IPs as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Innovative high-performance FPGA architecture, high-speed SERDES with PCS support, sysMEM embedded memory and high performance I/O are combined in the LatticeSC to provide excellent performance for today's leading edge systems designs. Table 1-3 details the performance of several common functions implemented within the LatticeSC.

Table1-3. Speed Performance for Typical Functions[1]

Functions	Performance (MHz)[2]
32-bit Address Decoder	539
64-bit Address Decoder	517
32:1 Multiplexer	779
64-bit Adder (ripple)	353
32x8 Distributed Single Port (SP) RAM	768
64-bit Counter (up or down counter, non-loadable)	369
True Dual-Port 1024x18 bits	372
FIFO Port A: x36 bits, B: x9 bits	375

1. For additional information, see Typical Building BLock Function Performance table in this data sheet.
2. Advance information (-7 speed grade).

Figure 2-3. Slice Diagram

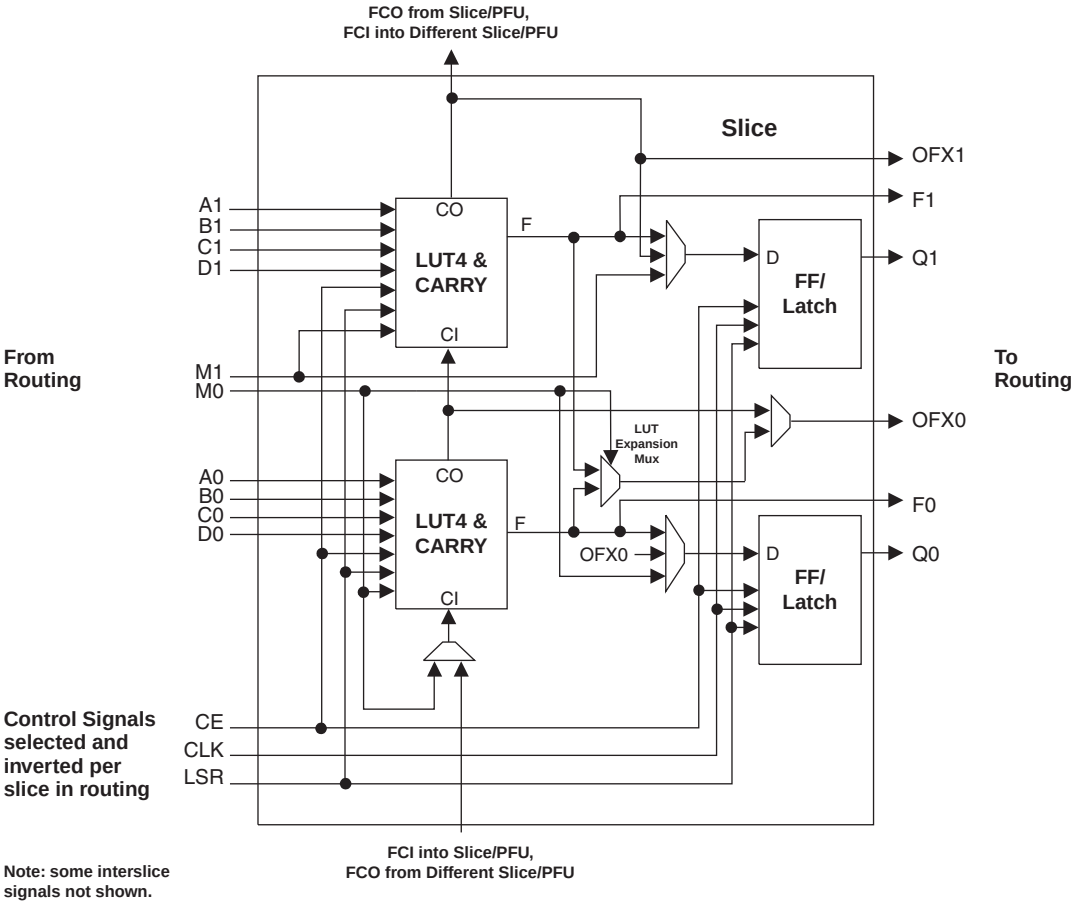


Table 2-1. Slice Signal Descriptions

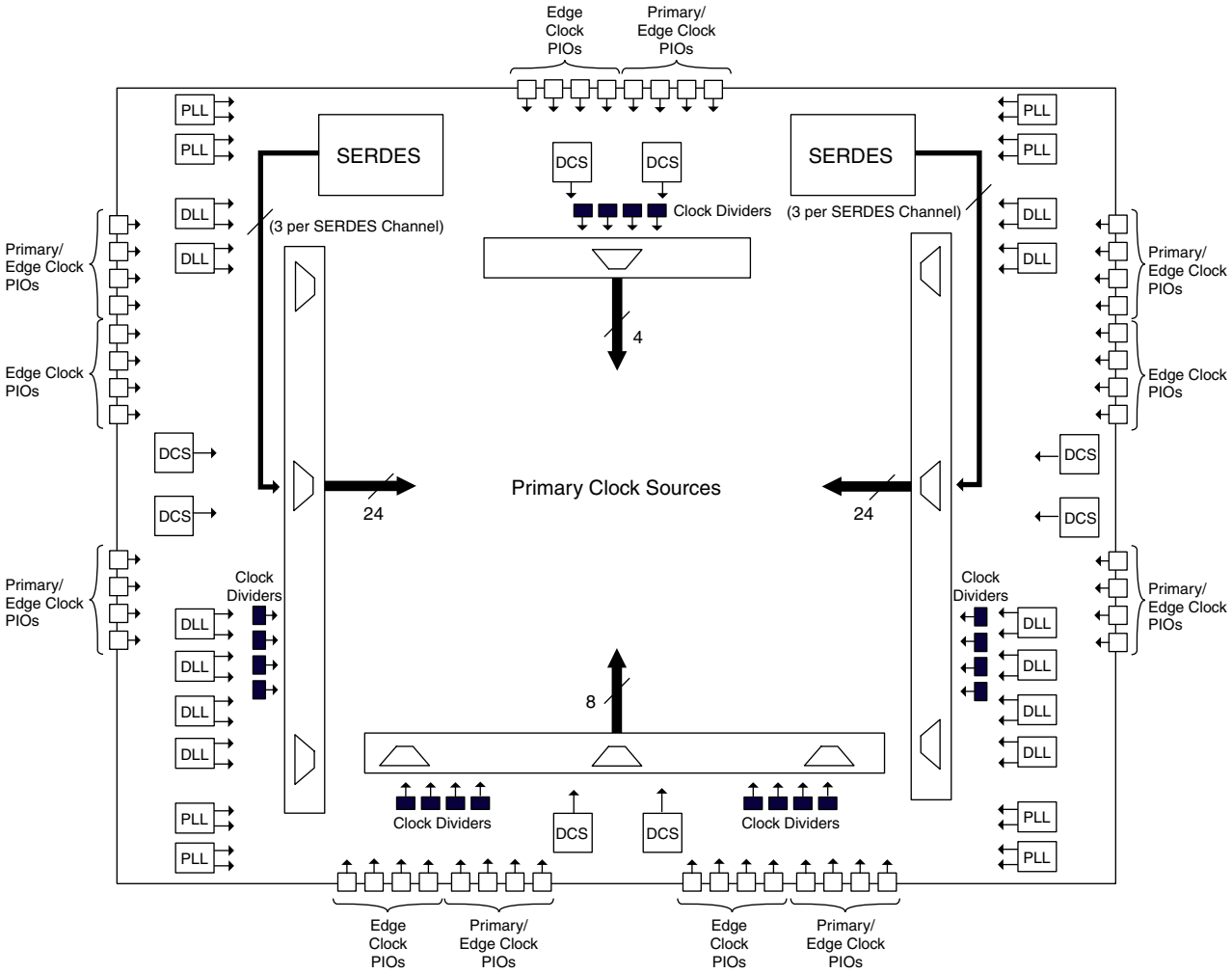
Function	Type	Signal Names	Description
Input	Data signal	A0, B0, C0, D0	Inputs to LUT4
Input	Data signal	A1, B1, C1, D1	Inputs to LUT4
Input	Multi-purpose	M0	Multipurpose Input
Input	Multi-purpose	M1	Multipurpose Input
Input	Control signal	CE	Clock Enable
Input	Control signal	LSR	Local Set/Reset
Input	Control signal	CLK	System Clock
Input	Inter-PFU signal	FCI	Fast Carry In[1]
Output	Data signals	F0, F1	LUT4 output register bypass signals
Output	Data signals	Q0, Q1	Register Outputs
Output	Data signals	OFX0	Output of a LUT5 MUX
Output	Data signals	OFX1	Output of a LUT6, LUT7, LUT8[2] MUX depending on the slice
Output	Inter-PFU signal	FCO	For the right most PFU the fast carry chain output[2]

1. See Figure 2-2 for connection details.
2. Requires two PFUs.

- Two outputs per PLL
- Clock divider outputs
- Digital Clock Select (DCS) block outputs
- Three outputs per SERDES quad

Figure 2-5 shows the arrangement of the primary clock sources.

Figure 2-5. Clock Sources



Primary Clock Routing

The clock routing structure in LatticeSC devices consists of 12 Primary Clock lines per quadrant. The primary clocks are generated from 64:1 MUXs located in each quadrant. Three of the inputs to each 64:1 MUX comes from local routing, one is connected to GND and rest of the 60 inputs are from the primary clock sources. Figure 2-6 shows this clock routing.

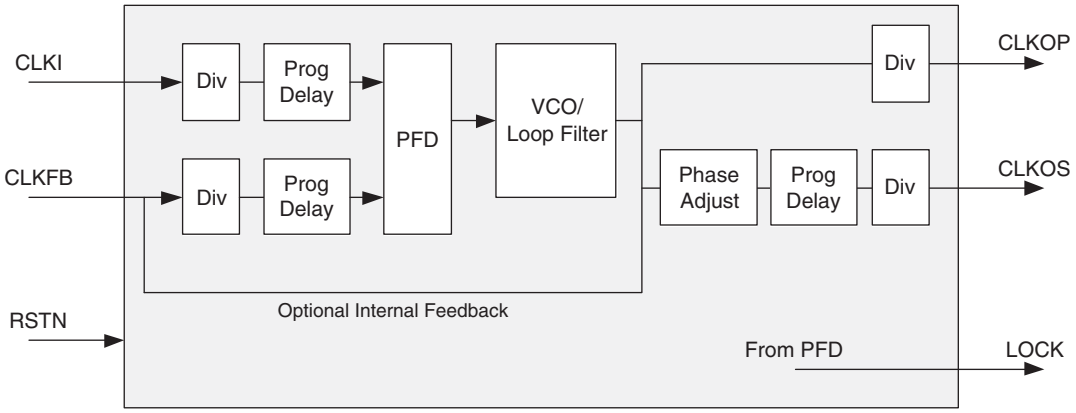
The setup and hold times of the device can be improved by programming a delay in the feedback or input path of the PLL which will advance or delay the output clock with reference to the input clock. This delay can be either programmed during configuration or can be adjusted dynamically.

The Phase Select block can modify the phase of the clock signal if desired. The Spread Spectrum block supports the modulation of the PLL output frequency. This reduces the peak energy in the fundamental and its harmonics providing for lower EMI (Electro Magnetic Interference).

The sysCLOCK PLL can be configured at power-up and then, if desired, reconfigured dynamically through the serial memory interface bus which connects with the on-chip system bus. For example, the user can select inputs, loop filters, divider setting, delay settings and phase shift settings. The user can also directly access the SMI bus through the routing.

The PLL clock input, from pin or routing, feeds into an input divider. There are four sources of feedback signal to the feedback divider: from the clock net, directly from the voltage controlled oscillator (VCO) output, from the routing or from an external pin. The signal from the input clock divider and the feedback divider are passed through the programmable delay before entering the phase frequency detector (PFD) unit. The output of this PFD is used to control the voltage controlled oscillator. There is a PLL_LOCK signal to indicate that VCO has locked on to the input clock signal. Figure 2-11 shows the sysCLOCK PLL diagram.

Figure 2-11. PLL Diagram



For more information on the PLL, please see details of additional technical documentation at the end of this data sheet.

Spread Spectrum Clocking (SSC)

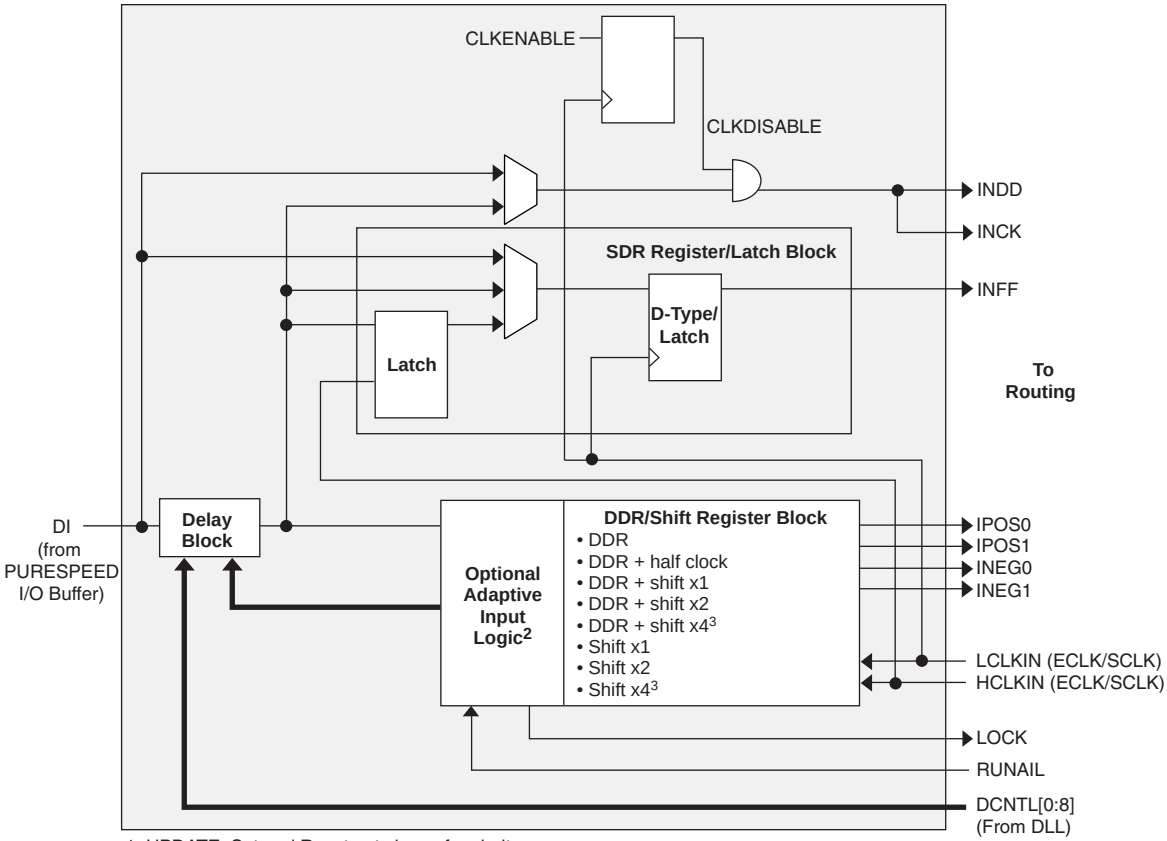
The PLL supports spread spectrum clocking to reduce peak EMI by using “down-spread” modulation. The spread spectrum operation will vary the output frequency (at 30KHz to 500KHz) in a range that is between its nominal value, down to a frequency that is a programmable 1%, 2%, or 3% lower than normal.

Digital Locked Loop (DLLs)

In addition to PLLs, the LatticeSC devices have up to 12 DLLs per device. DLLs assist in the management of clocks and strobes. DLLs are well suited to applications where the clock may be stopped or transferring jitter from input to output is important, for example forward clocked interfaces. PLLs are good for applications requiring the lowest output jitter or jitter filtering. All DLL outputs are routed as primary/edge clock sources.

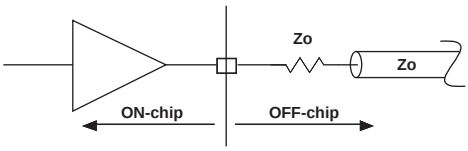
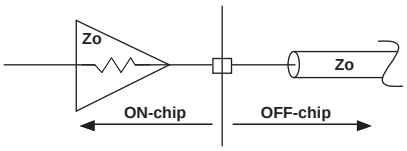
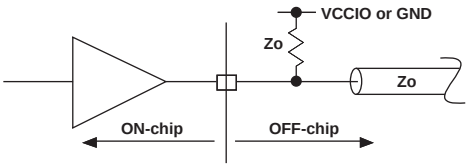
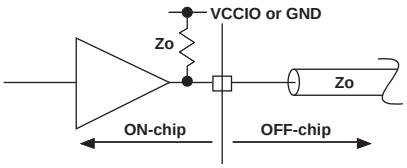
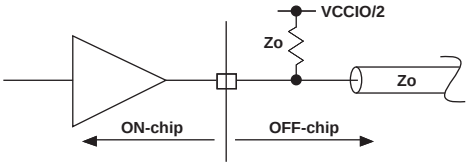
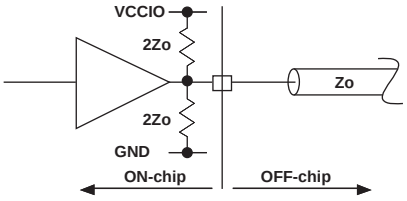
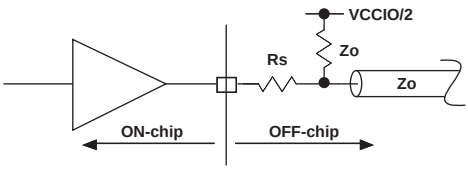
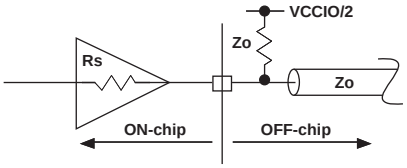
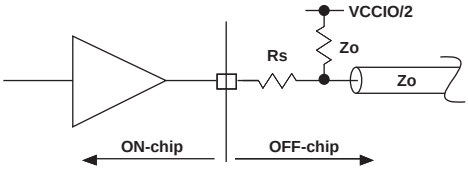
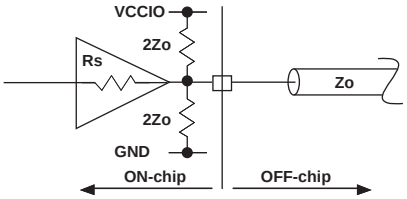
The DLL has two independent clock outputs, CLKOP and CLKOS. These outputs can individually select one of the outputs from the tapped delay line. The CLKOS has optional fine phase shift and divider blocks to allow this output to be further modified, if required. The fine phase shift block allows the CLKOS output to phase shifted a further 45, 22.5 or 11.25 degrees relative to its normal position. LOCK output signal is asserted when the DLL is locked. The ALU HOLD signal setting allows users to freeze the DLL at its current delay setting.

Figure 2-20. Input Register Block[1]



1. UPDATE, Set and Reset not shown for clarity
2. Adaptive input logic is only available in selected PIO
3. By four shift modes utilize DDR/shift register block from paired PIO.
4. CLKDISABLE is used to block the transitions on the DQS pin during post-amble. Its main use is to disable DQS (typically found in DDR memory interfaces) or other clock signals. It can also be used to disable any/all input signals to save power.

Figure 2-27. Output Termination Schemes

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Series termination (controlled output impedance)		
Parallel termination to V_{CCIO}, or parallel driving end		
Parallel termination to $V_{CCIO}/2$ driving end		
Combined series + parallel termination to $V_{CCIO}/2$ at driving end (only series termination moved on-chip)		
Combined series + parallel to $V_{CCIO}/2$ driving end		

BLVDS

The LatticeSC devices support BLVDS standard. This standard is emulated using controlled impedance complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

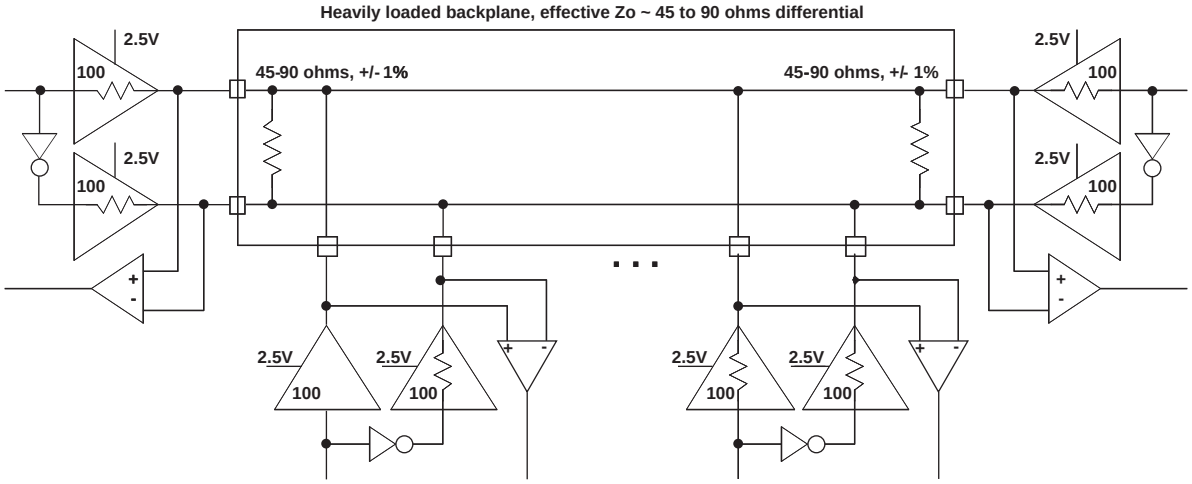


Table 3-2. BLVDS DC Conditions[1]

Over Recommended Operating Conditions

Symbol	Description	Nominal		Units
		Zo = 45	Zo = 90	
Z_{OUT}	Output impedance	100	100	ohm
R_{TLEFT}	Left end termination	45	90	ohm
R_{TRIGHT}	Right end termination	45	90	ohm
V_{OH}	Output high voltage	1.375	1.48	V
V_{OL}	Output low voltage	1.125	1.02	V
V_{OD}	Output differential voltage	0.25	0.46	V
V_{CM}	Output common mode voltage	1.25	1.25	V
I_{DC}	DC output current	11.2	10.2	mA

1. For input buffer, see LVDS table.

LatticeSC/M Internal Timing Parameters[1]

Over Recommended Commercial Operating Conditions at VCC = 1.2V +/- 5%

Parameter	Symbol	Description	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
PFU Logic Mode Timing									
t_{LUT4_PFU}	CTOF_DEL	LUT4 delay (A to D inputs to F output)	—	0.045	—	0.050	—	0.054	ns
t_{LUT5_PFU}	MTOOFX_DEL	LUT5 delay (inputs to output)	—	0.152	—	0.172	—	0.192	ns
t_{LSR_PFU}	LSR_DEL	Set/Reset to output (asynchronous)	—	0.378	—	0.426	—	0.474	ns
t_{SUM_PFU}	M_SET	Clock to Mux (M0,M1) input setup time	0.113	—	0.131	—	0.148	—	ns
t_{HM_PFU}	M_HLD	Clock to Mux (M0,M1) input hold time	-0.041	—	-0.046	—	-0.052	—	ns
t_{SUD_PFU}	DIN_SET	Clock to D input setup time	0.072	—	0.083	—	0.094	—	ns
t_{HD_PFU}	DIN_HLD	Clock to D input hold time	-0.028	—	-0.032	—	-0.035	—	ns
t_{CK2Q_PFU}	REG_DEL	Clock to Q delay, D-type register configuration	—	0.224	—	0.252	—	0.279	ns
t_{LE2Q_PFU}	LTCH_DEL	Clock to Q delay latch configuration	—	0.294	—	0.331	—	0.367	ns
t_{LD2Q_PFU}	TLTCH_DEL	D to Q throughput delay when latch is enabled	—	0.300	—	0.338	—	0.376	ns
PFU Memory Mode Timing									
t_{CORAM_PFU}	CLKTOF_DEL	Clock to Output	—	0.575	—	0.649	—	0.724	ns
t_{SUDATA_PFU}	DIN_SET	Data Setup Time	-0.024	—	-0.026	—	-0.027	—	ns
t_{HDATA_PFU}	DIN_HLD	Data Hold Time	0.075	—	0.084	—	0.094	—	ns
t_{SUADDR_PFU}	WAD_SET	Address Setup Time	-0.176	—	-0.196	—	-0.215	—	ns
t_{HADDR_PFU}	WAD_HLD	Address Hold Time	0.110	—	0.124	—	0.138	—	ns
t_{SUWREN_PFU}	WE_SET	Write/Read Enable Setup Time	0.014	—	0.019	—	0.024	—	ns
t_{HWREN_PFU}	WE_HLD	Write/Read Enable Hold Time	0.078	—	0.086	—	0.094	—	ns
PIC Timing									
PIO Input/Output Buffer Timing									
t_{IN_PIO}	IN_DEL	Input Buffer Delay(LVCMOS25)	—	0.578	—	0.661	—	0.744	ns
t_{OUT_PIO}	DOPADI_DEL	Output Buffer Delay(LVCMOS25)	—	2.712	—	3.027	—	3.395	ns
t_{SUI_PIO}	DIN_SET	Input Register Setup Time (Data Before Clock)	0.277	—	0.312	—	0.348	—	ns
t_{HI_PIO}	DIN_HLD	Input Register Hold Time (Data after Clock)	-0.267	—	-0.306	—	-0.345	—	ns
t_{COO_PIO}	CK_DEL	Output Register Clock to Output Delay	—	0.513	—	0.571	—	0.639	ns
t_{SUCE_PIO}	CE_SET	Input Register Clock Enable Setup Time	—	0.000	—	0.000	—	0.000	ns
t_{HCE_PIO}	CE_HLD	Input Register Clock Enable Hold Time	—	0.129	—	0.145	—	0.161	ns
t_{SULSR_PIO}	LSR_SET	Set/Reset Setup Time	0.057	—	0.060	—	0.063	—	ns
t_{HLSR_PIO}	LSR_HLD	Set/Reset Hold Time	-0.151	—	-0.159	—	-0.169	—	ns
t_{LE2Q_PIO}	CK_DEL	Input Register Clock to Q delay latch configuration	—	0.335	—	0.372	—	0.410	ns
t_{LD2Q_PIO}	DIN_DEL	Input Register D to Q throughput delay when latch is enabled	—	0.578	—	0.647	—	0.717	ns

sysCLOCK PLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)		2	—	1000	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)		1.5625	—	1000	MHz
f_{VCO}	PLL VCO Frequency		100	—	1000	MHz
f_{PFD}	Phase Detector Input Frequency		2	—	700	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default duty cycle selected (at 50% levels)	45	—	55	%
t_{OPJIT}[1]	Output Clock Period Jitter	2 MHz ≤ f_{PFD} ≤ 10 MHz	—	—	200	ps
		f_{PFD} > 10 MHz	—	—	100	ps
t_{CPJIT}[1]	Output Clock Cycle-to-Cycle Jitter		—	—	100	ps
t_{SKEW}	Output Clock-to-Clock Skew (Between Two Outputs with the Same Phase Setting)		—	—	20	ps
t_{LOCK}	PLL Lock-in Time		—	—	1	ms
t_{IPJIT}	Input Clock Period Jitter		—	—	±250	ps
t_{HI}	Input Clock High Time	At 80% level	350	—	—	ps
t_{LO}	Input Clock Low Time	At 20% level	350	—	—	ps
t_{RSWA}	Analog Reset Signal Pulse Width		100	—	—	ns
t_{RSWD}	Digital Reset Signal Pulse Width		3	—	—	ns
t_{DEL}	Timeshift Delay Step Size		40	80	120	ps
t_{RANGE}	Timeshift Delay Range		—	+/- 560	—	ps
f_{SS}	Spread Spectrum Modulation Frequency		30	—	500	KHz
% Spread	Percentage Downspread for SS Mode		0.5	—	1.5	%
	VCO Clock Phase Adjustment Accuracy		-5	—	5	°

1. Values are measured with FPGA logic active, no additional I/Os toggling and REFCLK total jitter = 30 ps

LatticeSC/M sysCONFIG Port Timing (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Asynchronous Peripheral Configuration Mode				
t_{WRAP}	WRN, CS0N and CS1 Pulse Width	5	-	ns
t_{SAP}	D[7:0] Setup Time	1.5	-	ns
t_{RDYAP}	RDY Delay	—	8	ns
t_{BAP}	RDY Low	1	8	CCLK periods
t_{WR2AP}	Earliest WRN After RDY Goes High	0	—	ns
t_{DENAP}	RDN to D[7:0] Enable/Disable	—	7.5	ns
t_{DAP}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Serial Configuration Mode				
t_{SSS}	DIN Setup Time	5.2	—	ns
t_{HSS}	DIN Hold Time	0	—	ns
t_{CHSS}	CCLK High Time	3.75	—	ns
t_{CLSS}	CCLK Low Time	3.75	—	ns
f_{CSS}	CCLK Frequency	—	150	MHz
t_{DSS}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Parallel Configuration Mode				
t_{S1SP}	CS0N, CS1, WRN Setup Time	5.2	—	ns
t_{H1SP}	CS0N, CS1, WRN Hold Time	0	—	ns
t_{S2SP}	D[7:0] Setup Time	5.2	—	ns
t_{H2SP}	D[7:0] Hold Time	0	—	ns
t_{CHSP}	CCLK High Time	3.75	—	ns
t_{CL}	CCLK Low Time	3.75	—	ns
f_{CSP}	CCLK Frequency	—	150	MHz

sysCONFIG MPI Port

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{MPICTRL\_SET}$	MPI Control (MPCSTRBN, MPCWRN, MPCCLK, etc.) to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
t_{MPIADR_SET}	MPI Address to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPIDAT_SET}	MPI Write Data to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
$t_{MPIDPAR\_SET}$	MPI Write Parity Data to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPI_HLD}	All Hold Times	0	—	0	—	0	—	ns
$t_{MPICTRL\_DEL}$	MPCCLK to MPI Control (MPCTA, MPC-TEA, MPCRETRY)	—	5.6	—	6.7	—	8.7	ns
t_{MPIDAT_DEL}	MPCCLK to MPI Data	—	5.6	—	6.7	—	8.7	ns
$t_{MPIDPAR\_DEL}$	MPCCLK to MPI Parity Data	—	4.9	—	5.7	—	7.7	ns
$f_{MPI\_CLK\_FRQ}$	MPCCLK Frequency	—	100	—	83	—	66	MHz

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA[1, 2] (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
N3	PL27A	6		PL30A	6	
P3	PL27B	6		PL30B	6	
P4	PL27C	6	PCLKT6_3	PL30C	6	PCLKT6_3
P2	PL28A	6		PL31A	6	
R2	PL28B	6		PL31B	6	
T3	PL28C	6	PCLKT6_2	PL31C	6	PCLKT6_2
R3	PL28D	6	PCLKC6_2	PL31D	6	PCLKC6_2
P1	PL31A	6		PL34A	6	
R1	PL31B	6		PL34B	6	
R5	PL31C	6	VREF1_6	PL34C	6	VREF1_6
R4	PL31D	6		PL34D	6	
T2	PL32A	6		PL35A	6	
U2	PL32B	6		PL35B	6	
T1	PL33A	6		PL38A	6	
U1	PL33B	6		PL38B	6	
V1	PL35A	6		PL42A	6	
W1	PL35B	6		PL42B	6	
V6	PL35D	6	DIFFR_6	PL42D	6	DIFFR_6
V2	PL36A	6		PL43A	6	
W2	PL36B	6		PL43B	6	
Y1	PL37A	6		PL44A	6	
AA1	PL37B	6		PL44B	6	
AB1	PL39A	6		PL48A	6	
AC1	PL39B	6		PL48B	6	
Y5	PL40A	6		PL49A	6	
Y6	PL40B	6		PL49B	6	
AD2	PL41A	6		PL51A	6	
AE2	PL41B	6		PL51B	6	
AB5	PL41D	6	VREF2_6	PL51D	6	VREF2_6
AC3	PL43A	6		PL52A	6	
AD3	PL43B	6		PL52B	6	
AF1	PL44A	6		PL55A	6	
AG1	PL44B	6		PL55B	6	
AB6	PL44C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F	PL55C	6	LLC_DLLT_IN_E/LLC_DLLT_FB_F
AC5	PL44D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F	PL55D	6	LLC_DLLC_IN_E/LLC_DLLC_FB_F
AF2	PL45A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E	PL57A	6	LLC_DLLT_IN_F/LLC_DLLT_FB_E
AG2	PL45B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E	PL57B	6	LLC_DLLC_IN_F/LLC_DLLC_FB_E
AC6	PL45C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A	PL57C	6	LLC_PLLT_IN_B/LLC_PLLT_FB_A
AC7	PL45D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A	PL57D	6	LLC_PLLC_IN_B/LLC_PLLC_FB_A
AE4	XRES	-		XRES	-	
AG4	VCC12	-		VCC12	-	
AD5	TEMP	6		TEMP	6	
AF5	VCC12	-		VCC12	-	
AH1	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B	PB3A	5	LLC_PLLT_IN_A/LLC_PLLT_FB_B
AJ1	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B	PB3B	5	LLC_PLLC_IN_A/LLC_PLLC_FB_B

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
P32	PL30A	6		PL39A	6	
P31	PL30B	6		PL39B	6	
R28	PL30C	6	PCLKT6_3	PL39C	6	PCLKT6_3
T28	PL30D	6	PCLKC6_3	PL39D	6	PCLKC6_3
R30	PL31A	6		PL40A	6	
R29	PL31B	6		PL40B	6	
T25	PL31C	6	PCLKT6_2	PL40C	6	PCLKT6_2
T26	PL31D	6	PCLKC6_2	PL40D	6	PCLKC6_2
R31	PL34A	6		PL43A	6	
R32	PL34B	6		PL43B	6	
U23	PL34C	6	VREF1_6	PL43C	6	VREF1_6
U24	PL34D	6		PL43D	6	
T31	PL35A	6		PL44A	6	
T32	PL35B	6		PL44B	6	
T27	PL35C	6		PL44C	6	
U28	PL35D	6		PL44D	6	
U32	PL36A	6		PL45A	6	
U31	PL36B	6		PL45B	6	
U26	PL36C	6		PL45C	6	
U25	PL36D	6		PL45D	6	
V32	PL38A	6		PL47A	6	
V31	PL38B	6		PL47B	6	
V24	PL38C	6		PL47C	6	
V23	PL38D	6		PL47D	6	
V29	PL39A	6		PL48A	6	
V30	PL39B	6		PL48B	6	
U27	PL39C	6		PL48C	6	
V28	PL39D	6		PL48D	6	
W30	PL40A	6		PL49A	6	
W29	PL40B	6		PL49B	6	
V25	PL40C	6		PL49C	6	
W26	PL40D	6		PL49D	6	
W31	PL42A	6		PL51A	6	
Y31	PL42B	6		PL51B	6	
W27	PL42C	6		PL51C	6	
Y27	PL42D	6	DIFFR_6	PL51D	6	DIFFR_6
W28	PL43A	6		PL52A	6	
Y28	PL43B	6		PL52B	6	
Y26	PL43C	6		PL52C	6	
W25	PL43D	6		PL52D	6	
W32	PL44A	6		PL53A	6	
Y32	PL44B	6		PL53B	6	
AB28	PL44C	6		PL53C	6	
AA28	PL44D	6		PL53D	6	
AB32	PL47A	6		PL60A	6	
AA32	PL47B	6		PL60B	6	
AB27	PL47C	6		PL60C	6	
AC27	PL47D	6		PL60D	6	
AD31	PL48A	6		PL61A	6	
AC31	PL48B	6		PL61B	6	

LFSC/M25, LFSC/M40 Logic Signal Connections: 1020 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M25			LFSC/M40		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
B30	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
D30	A_VDDOB0_L	-		A_VDDOB0_L	-	
A30	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
C31	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
C32	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
B31	A_VDDIB0_L	-		A_VDDIB0_L	-	
AL25	NC	-		PB26A	5	
AL24	NC	-		PB26B	5	
AG27	NC	-		PB26C	5	
AH27	NC	-		PB26D	5	
AM25	NC	-		PB27A	5	
AM24	NC	-		PB27B	5	
AL9	NC	-		PB62A	4	
AL8	NC	-		PB62B	4	
AK9	NC	-		PB63A	4	
AJ9	NC	-		PB63B	4	
AG10	NC	-		PB63C	4	
AG11	NC	-		PB63D	4	
J30	NC	-		PL26A	7	
H30	NC	-		PL26B	7	
M28	NC	-		PL26C	7	
N28	NC	-		PL26D	7	
J32	NC	-		PL27A	7	
J31	NC	-		PL27B	7	
N26	NC	-		PL27C	7	
N27	NC	-		PL27D	7	
K31	NC	-		PL29A	7	
K32	NC	-		PL29B	7	
P25	NC	-		PL29C	7	
P26	NC	-		PL29D	7	
L27	NC	-		PL22C	7	
L28	NC	-		PL22D	7	
M29	NC	-		PL30A	7	
L29	NC	-		PL30B	7	
M30	NC	-		PL31A	7	
L30	NC	-		PL31B	7	
L31	NC	-		PL34A	7	
M31	NC	-		PL34B	7	
AA29	NC	-		PL56A	6	
AA30	NC	-		PL56B	6	
AB31	NC	-		PL57A	6	
AA31	NC	-		PL57B	6	
AG30	NC	-		PL57C	6	
AG29	NC	-		PL57D	6	
AB29	NC	-		PL58A	6	
AB30	NC	-		PL58B	6	
Y25	NC	-		PL58C	6	
AA25	NC	-		PL58D	6	
AA8	NC	-		PR58D	3	
Y8	NC	-		PR58C	3	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH11	PB57D	4		PB79D	4	
AN13	PB58A	4	PCLKT4_3	PB80A	4	PCLKT4_3
AN12	PB58B	4	PCLKC4_3	PB80B	4	PCLKC4_3
AD14	PB58C	4	PCLKT4_4	PB80C	4	PCLKT4_4
AD15	PB58D	4	PCLKC4_4	PB80D	4	PCLKC4_4
AP13	PB61A	4		PB73A	4	
AP12	PB61B	4		PB73B	4	
AK13	PB61C	4		PB73C	4	
AK12	PB61D	4		PB73D	4	
AP11	PB62A	4		PB83A	4	
AP10	PB62B	4		PB83B	4	
AN11	PB63A	4		PB99A	4	
AN10	PB63B	4		PB99B	4	
AF14	PB63C	4		PB99C	4	
AF13	PB63D	4		PB99D	4	
AM10	PB67A	4		PB101A	4	
AM9	PB67B	4		PB101B	4	
AE14	PB67C	4		PB101C	4	
AE13	PB67D	4		PB101D	4	
AP9	PB69A	4		PB104A	4	
AP8	PB69B	4		PB104B	4	
AK11	PB69C	4		PB104C	4	
AK10	PB69D	4		PB104D	4	
AL10	PB70A	4		PB107A	4	
AL9	PB70B	4		PB107B	4	
AF12	PB70C	4		PB107C	4	
AF11	PB70D	4		PB107D	4	
AN9	PB73A	4		PB109A	4	
AN8	PB73B	4		PB109B	4	
AG11	PB73C	4		PB109C	4	
AG10	PB73D	4		PB109D	4	
AP7	PB74A	4		PB111A	4	
AP6	PB74B	4		PB111B	4	
AG13	PB74C	4		PB111C	4	
AG12	PB74D	4		PB111D	4	
AN7	PB75A	4		PB113A	4	
AN6	PB75B	4		PB113B	4	
AK9	PB75C	4		PB113C	4	
AK8	PB75D	4		PB113D	4	
AP5	PB77A	4		PB115A	4	
AP4	PB77B	4		PB115B	4	
AD11	PB77C	4		PB115C	4	
AE11	PB77D	4		PB115D	4	
AM7	PB78A	4		PB117A	4	
AM6	PB78B	4		PB117B	4	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AC19	VTT_5	5		VTT_5	5	
AC20	VTT_5	5		VTT_5	5	
AD22	VTT_5	5		VTT_5	5	
AB24	VTT_6	6		VTT_6	6	
W23	VTT_6	6		VTT_6	6	
Y23	VTT_6	6		VTT_6	6	
N24	VTT_7	7		VTT_7	7	
R23	VTT_7	7		VTT_7	7	
T23	VTT_7	7		VTT_7	7	
M12	VDDAX25_R	-		VDDAX25_R	-	
M23	VDDAX25_L	-		VDDAX25_L	-	
Y16	GND	-		GND	-	
Y14	GND	-		GND	-	
N21	VCC12	-		VCC12	-	
P22	VCC12	-		VCC12	-	
AA22	VCC12	-		VCC12	-	
AB21	VCC12	-		VCC12	-	
AB14	VCC12	-		VCC12	-	
AA13	VCC12	-		VCC12	-	
P13	VCC12	-		VCC12	-	
N14	VCC12	-		VCC12	-	
G26	NC	-		NC	-	
G9	NC	-		NC	-	
J12	NC	-		NC	-	
H12	NC	-		NC	-	
H23	NC	-		NC	-	
J23	NC	-		NC	-	

1. Differential pair grouping within a PCI is A (True) and B (complement) and C (True) and D (Complement).
2. The LatticeSC/M40 and LatticeSC/M80 in an 1152-pin package support a 32-bit MPI interface.

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
AD5	PR94C	3	
AE2	PR94B	3	
AD2	PR94A	3	
AC5	PR92D	3	
AB5	PR92C	3	
AF1	PR92B	3	
AE1	PR92A	3	
AA11	PR91D	3	
Y11	PR91C	3	
AC4	PR91B	3	
AB4	PR91A	3	
AA8	PR90D	3	DIFFR_3
AA9	PR90C	3	
AC3	PR90B	3	
AB3	PR90A	3	
AA7	PR79D	3	
Y7	PR79C	3	
AA2	PR79B	3	
Y2	PR79A	3	
AA6	PR77D	3	
Y6	PR77C	3	
Y4	PR77B	3	
W4	PR77A	3	
W11	PR74D	3	
V11	PR74C	3	
W2	PR74B	3	
V2	PR74A	3	
W9	PR71D	3	
V9	PR71C	3	
V1	PR71B	3	
U1	PR71A	3	
W10	PR70D	3	
V10	PR70C	3	
U2	PR70B	3	
T2	PR70A	3	
Y8	PR69D	3	
W8	PR69C	3	VREF1_3
W5	PR69B	3	
V5	PR69A	3	
V7	PR66D	3	PCLKC3_2
U7	PR66C	3	PCLKT3_2
T1	PR66B	3	
R1	PR66A	3	

LFSC/M115 Logic Signal Connections: 1152 fcBGA[1, 2]

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
K26	GND	-	
K28	GND	-	
K6	GND	-	
K9	GND	-	
L12	GND	-	
L32	GND	-	
L4	GND	-	
M10	GND	-	
M17	GND	-	
M24	GND	-	
N29	GND	-	
N7	GND	-	
P15	GND	-	
P20	GND	-	
P3	GND	-	
P31	GND	-	
R10	GND	-	
R14	GND	-	
R16	GND	-	
R19	GND	-	
R21	GND	-	
R26	GND	-	
T15	GND	-	
T17	GND	-	
T18	GND	-	
T20	GND	-	
T28	GND	-	
T6	GND	-	
U16	GND	-	
U19	GND	-	
U23	GND	-	
U32	GND	-	
U4	GND	-	
V12	GND	-	
V16	GND	-	
V19	GND	-	
V3	GND	-	
V31	GND	-	
W15	GND	-	
W17	GND	-	
W18	GND	-	
W20	GND	-	
W29	GND	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA[1, 2] (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AU9	PB103C	4		PB117C	4	
AU8	PB103D	4		PB117D	4	
AY8	PB104A	4		PB118A	4	
AY7	PB104B	4		PB118B	4	
AU7	PB104C	4		PB118C	4	
AU6	PB104D	4		PB118D	4	
BA7	PB105A	4		PB119A	4	
BA6	PB105B	4		PB119B	4	
AN13	PB105C	4		PB119C	4	
AN12	PB105D	4		PB119D	4	
AV9	PB107A	4		PB121A	4	
AV8	PB107B	4		PB121B	4	
AT10	PB107C	4		PB121C	4	
AT9	PB107D	4		PB121D	4	
AW8	PB108A	4		PB122A	4	
AW7	PB108B	4		PB122B	4	
AP11	PB108C	4		PB122C	4	
AP10	PB108D	4		PB122D	4	
BB5	PB109A	4		PB123A	4	
BB4	PB109B	4		PB123B	4	
AR10	PB109C	4		PB123C	4	
AR9	PB109D	4		PB123D	4	
BA5	PB111A	4		PB125A	4	
BA4	PB111B	4		PB125B	4	
AT7	PB111C	4		PB125C	4	
AT6	PB111D	4		PB125D	4	
BB3	PB112A	4		PB126A	4	
BA3	PB112B	4		PB126B	4	
AM14	PB112C	4		PB126C	4	
AL14	PB112D	4		PB126D	4	
AY5	PB113A	4		PB127A	4	
AY4	PB113B	4		PB127B	4	
AN11	PB113C	4		PB127C	4	
AN10	PB113D	4		PB127D	4	
AV7	PB115A	4		PB129A	4	
AV6	PB115B	4		PB129B	4	
AM12	PB115C	4		PB129C	4	
AM11	PB115D	4		PB129D	4	
AW5	PB116A	4		PB130A	4	
AW4	PB116B	4		PB130B	4	
AT5	PB116C	4		PB130C	4	
AT4	PB116D	4		PB130D	4	
AY2	PB117A	4		PB131A	4	
BA2	PB117B	4		PB131B	4	
AP9	PB117C	4		PB131C	4	

Industrial

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA15E-6FN256I	-6	Lead-Free fpBGA	256	IND	15.2
LFSC3GA15E-5FN256I	-5	Lead-Free fpBGA	256	IND	15.2
LFSC3GA15E-6FN900I	-6	Lead-Free fpBGA	900	IND	15.2
LFSC3GA15E-5FN900I	-5	Lead-Free fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA15EP1-6FN256I	-6	Lead-Free fpBGA	256	IND	15.2
LFSCM3GA15EP1-5FN256I	-5	Lead-Free fpBGA	256	IND	15.2
LFSCM3GA15EP1-6FN900I	-6	Lead-Free fpBGA	900	IND	15.2
LFSCM3GA15EP1-5FN900I	-5	Lead-Free fpBGA	900	IND	15.2

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA25E-6FN900I	-6	Lead-Free fpBGA	900	IND	25.4
LFSC3GA25E-5FN900I	-5	Lead-Free fpBGA	900	IND	25.4
LFSC3GA25E-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	25.4
LFSC3GA25E-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	25.4
LFSC3GA25E-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4
LFSC3GA25E-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSCM3GA25EP1-6FN900I	-6	Lead-Free fpBGA	900	IND	25.4
LFSCM3GA25EP1-5FN900I	-5	Lead-Free fpBGA	900	IND	25.4
LFSCM3GA25EP1-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	25.4
LFSCM3GA25EP1-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4
LFSCM3GA25EP1-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	25.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.

Part Number	Grade	Package	Balls	Temp.	LUTs (K)
LFSC3GA40E-6FFN1020I[1]	-6	Lead-Free Organic fcBGA	1020	IND	40.4
LFSC3GA40E-5FFN1020I[1]	-5	Lead-Free Organic fcBGA	1020	IND	40.4
LFSC3GA40E-6FFAN1020I	-6	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-5FFAN1020I	-5	Lead-Free Organic fcBGA Revision 2	1020	IND	40.4
LFSC3GA40E-6FCN1152I[2]	-6	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-5FCN1152I[2]	-5	Lead-Free Ceramic fcBGA	1152	IND	40.4
LFSC3GA40E-6FFN1152I	-6	Lead-Free Organic fcBGA	1152	IND	40.4
LFSC3GA40E-5FFN1152I	-5	Lead-Free Organic fcBGA	1152	IND	40.4

1. Converted to organic flip-chip BGA package revision 2 per PCN #02A-10.
2. Converted to organic flip-chip BGA package per PCN #01A-10.

Date	Version	Section	Change Summary
March 2007 (cont.)	01.5 (cont.)	DC and Switching Characteristics (cont.)	Updated LatticeSC Internal Timing Parameters with ispLEVER 6.1 SP1 results.
			Updated t_{FDEL} and t_{CDEL} specifications.
			Updated LatticeSC Family Timing Adders with ispLEVER 6.1 SP1 results.
			Updated PLL specifications to expand frequency range down to 2 MHz and break out jitter for the different ranges.
			Added footnote to sysCLOCK PLL Timing table specifying the conditions for the jitter measurements.
			Added t_{DLL} specification to sysCLOCK DLL Timing table.
			Added footnote to sysCLOCK DLL Timing table specifying the conditions for the jitter measurements.
			Added sysCONFIG Master Parallel Configuration Mode and sysCONFIG SPI Port to LatticeSC sysCONFIG Port Timing table.
		Pin Information	Updated Pin Information Summary with SC40 information.
			Updated LFSC25 Logic Signal Connections: FF1020 with SC40 information.
			Updated LFSC80 Logic Signal Connections: FC1152 with SC40 information.
August 2007	01.6	General	Changed references of "HDC" to "HDC/SI".
			Changed references of "LDCN" to "LDCN/SCS".
			Changed references of "BUSYN/RCLK" to "BUSYN/RCLK/SCK".
			Changed references of "RDCFGN" to "TSALLN".
			Changed references of "TDO/RDDATA" to "TDO".
		Architecture	Updated text in Ripple Mode section.
			Added information to Global Set/Reset.
			Added information for Spread Spectrum Clocking
			Modified information for PLL/DLL Cascading. DLL to PLL is now supported.
			Modified AIL Block text and figure.
			Modified Figure 2-20 DDR/Shift Register Block.
			Added Information to Hot Socketing.
			Added new information for I/O Architecture Rules.
			Added information to SERDES Power Supply Sequencing Requirements.
		DC and Switching Characteristics	Added footnote to Hot Socketing Specifications table.
			Modified Initialization and Standby Supply Current table.
			Modified GSR Timing table.
			Modified sysCLOCK DLL Timing table to include $I_{DUTY.}$
			Deleted Readback Timing information from sysCONFIG Port Timing table.
			Modified data in External Switching Characteristics table.
		Pin Information	Added information to the Signal Descriptions table for HDC/SI, LDCN/SCS.
			Added footnote to Signal Descriptions table.
			Modified Description for signal BUSYN/RCLK/SCK.
			Modified data in Pin Information Summary and device-specific Pinout Information tables.